

NLSV4T244E

4-Bit Dual-Supply Non-Inverting Level Translator

The NLSV4T244E is a 4-bit configurable dual-supply voltage level translator. The input A_n and output B_n ports are designed to track two different power supply rails, V_{CCA} and V_{CCB} respectively. Both supply rails are configurable from 0.9 V to 4.5 V allowing universal low-voltage translation from the input A_n to the output B_n port.

Features

- Wide V_{CCA} and V_{CCB} Operating Range: 0.9 V to 4.5 V
- High-Speed w/ Balanced Propagation Delay
- Inputs and Outputs have OVT Protection to 4.5 V
- Non-preferential V_{CCA} and V_{CCB} Sequencing
- Outputs at 3-State until Active V_{CC} is Reached
- Power-Off Protection
- Outputs Switch to 3-State with V_{CCB} at GND
- Ultra-Small Packaging: 1.7 mm x 2.0 mm UQFN12
- These are Pb-Free Devices

Typical Applications

- Mobile Phones, PDAs, Other Portable Devices

Important Information

- ESD Protection for All Pins:
 - HBM (Human Body Model) > 2000 V
 - MM (Machine Model) > 400 V



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MARKING DIAGRAMS



UQFN12
MU SUFFIX
CASE 523AE

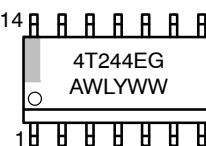


AF = Specific Device Code
M = Date Code
■ = Pb-Free Package

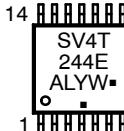
(Note: Microdot may be in either location)



SOIC-14
D SUFFIX
CASE 751A



TSSOP-14
DT SUFFIX
CASE 948G



A = Assembly Location
L, WL = Wafer Lot
Y, YY = Year
W, WW = Work Week
G or ■ = Pb-Free Package
(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
NLSV4T244EMUTAG	UQFN12 (Pb-Free)	3000/Tape & Reel
NLSV4T244EDR2G	SO-14 (Pb-Free)	2500/Tape & Reel
NLSV4T244EDTR2G	TSSOP14 (Pb-Free)	2500/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

NLSV4T244E

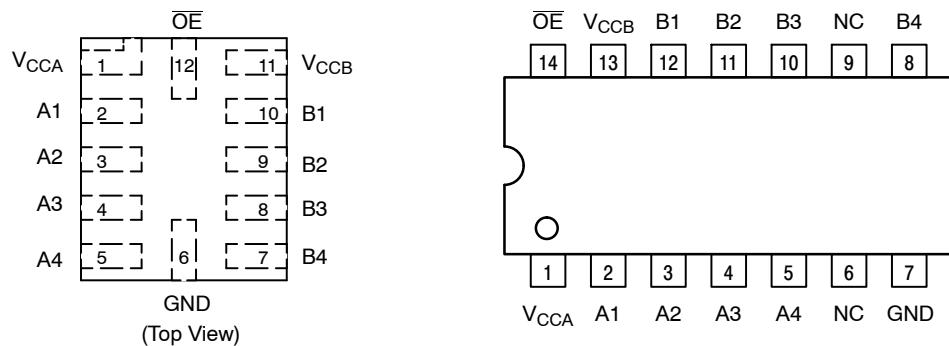


Figure 1. Pin Assignments

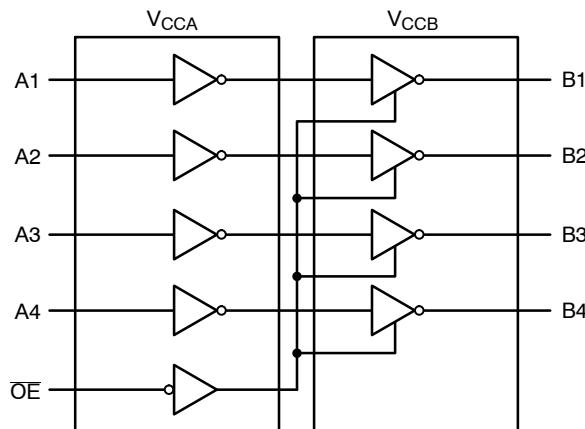


Figure 2. Logic Diagram

PIN ASSIGNMENT

PIN	FUNCTION
V _{CCA}	Input Port DC Power Supply
V _{CCB}	Output Port DC Power Supply
GND	Ground
A _n	Input Port
B _n	Output Port
OE	Output Enable

TRUTH TABLE

Inputs		Outputs
OE	A _n	B _n
L	L	L
L	H	H
H	X	3-State

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MAXIMUM RATINGS

Symbol	Rating	Value	Condition	Unit
V_{CCA}, V_{CCB}	DC Supply Voltage	-0.5 to +5.5		V
V_I	DC Input Voltage	A_n	-0.5 to +5.5	V
V_C	Control Input	OE	-0.5 to +5.5	V
V_O	DC Output Voltage (Power Down)	B_n	-0.5 to +5.5	$V_{CCA} = V_{CCB} = 0$
	(Active Mode)	B_n	-0.5 to +5.5	V
	(Tri-State Mode)	B_n	-0.5 to +5.5	V
I_{IK}	DC Input Diode Current	-20	$V_I < GND$	mA
I_{OK}	DC Output Diode Current	-50	$V_O < GND$	mA
I_O	DC Output Source/Sink Current	± 50		mA
I_{CCA}, I_{CCB}	DC Supply Current Per Supply Pin	± 100		mA
I_{GND}	DC Ground Current per Ground Pin	± 100		mA
T_{STG}	Storage Temperature	-65 to +150		°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V_{CCA}, V_{CCB}	Positive DC Supply Voltage	0.9	4.5	V
V_I	Bus Input Voltage	GND	4.5	V
V_C	Control Input	OE	GND	V
V_{IO}	Bus Output Voltage (Power Down Mode)	B_n	GND	V
	(Active Mode)	B_n	GND	V_{CCB}
	(Tri-State Mode)	B_n	GND	V
T_A	Operating Temperature Range	-40	+85	°C
$\Delta t / \Delta V$	Input Transition Rise or Rate V_I , from 30% to 70% of V_{CC} ; $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$	0	10	nS

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DC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Test Conditions	V_{CCA} (V)	V_{CCB} (V)	-40°C to +85°C		Unit
					Min	Max	
V_{IH}	Input HIGH Voltage (An, OE)		3.6 – 4.5	0.9 – 4.5	2.2	–	V
			2.7 – 3.6		2.0	–	
			2.3 – 2.7		1.6	–	
			1.4 – 2.3		0.65 * V_{CCA}	–	
			0.9 – 1.4		0.9 * V_{CCA}	–	
V_{IL}	Input LOW Voltage (An, OE)		3.6 – 4.5	0.9 – 4.5	–	0.8	V
			2.7 – 3.6		–	0.8	
			2.3 – 2.7		–	0.7	
			1.4 – 2.3		–	0.35 * V_{CCA}	
			0.9 – 1.4		–	0.1 * V_{CCA}	
V_{OH}	Output HIGH Voltage	$I_{OH} = -100 \mu A; V_I = V_{IH}$	0.9 – 4.5	0.9 – 4.5	$V_{CCB} - 0.2$	–	V
			$I_{OH} = -0.5 \text{ mA}; V_I = V_{IH}$	0.9	0.9	0.75 * V_{CCB}	
			$I_{OH} = -2 \text{ mA}; V_I = V_{IH}$	1.4	1.4	1.05	
			$I_{OH} = -6 \text{ mA}; V_I = V_{IH}$	1.65	1.65	1.25	
			2.3	2.3	2.0	–	
			$I_{OH} = -12 \text{ mA}; V_I = V_{IH}$	2.3	2.3	1.8	
			2.7	2.7	2.2	–	
			$I_{OH} = -18 \text{ mA}; V_I = V_{IH}$	2.3	2.3	1.7	–
			3.0	3.0	2.4	–	
			$I_{OH} = -24 \text{ mA}; V_I = V_{IH}$	3.0	3.0	2.2	–
V_{OL}	Output LOW Voltage	$I_{OL} = 100 \mu A; V_I = V_{IL}$	0.9 – 4.5	0.9 – 4.5	–	0.2	V
			$I_{OL} = 0.5 \text{ mA}; V_I = V_{IL}$	1.1	1.1	–	
			$I_{OL} = 2 \text{ mA}; V_I = V_{IL}$	1.4	1.4	–	
			$I_{OL} = 6 \text{ mA}; V_I = V_{IL}$	1.65	1.65	–	
			$I_{OL} = 12 \text{ mA}; V_I = V_{IL}$	2.3	2.3	–	
			2.7	2.7	–	0.4	
			$I_{OL} = 18 \text{ mA}; V_I = V_{IL}$	2.3	2.3	–	
			3.0	3.0	–	0.6	
			$I_{OL} = 24 \text{ mA}; V_I = V_{IL}$	3.0	3.0	–	0.6
I_I	Input Leakage Current	$V_I = V_{CCA}$ or GND	0.9 – 4.5	0.9 – 4.5	-1.0	1.0	μA
I_{OFF}	Power-Off Leakage Current	$\overline{OE} = 0 \text{ V}$	0 0.9 – 4.5	0.9 – 4.5 0	-1.0 -1.0	1.0 1.0	μA
I_{CCA}	Quiescent Supply Current	$V_I = V_{CCA}$ or GND; $I_O = 0$, $V_{CCA} = V_{CCB}$	0.9 – 4.5	0.9 – 4.5	–	2.0	μA
I_{CCB}	Quiescent Supply Current	$V_I = V_{CCA}$ or GND; $I_O = 0$, $V_{CCA} = V_{CCB}$	0.9 – 4.5	0.9 – 4.5	–	2.0	μA
$I_{CCA} + I_{CCB}$	Quiescent Supply Current	$V_I = V_{CCA}$ or GND; $I_O = 0$, $V_{CCA} = V_{CCB}$	0.9 – 4.5	0.9 – 4.5	–	4.0	μA
ΔI_{CCA}	Increase in I_{CC} per Input Voltage, Other Inputs at V_{CCA} or GND	$V_I = V_{CCA} - 0.6 \text{ V}$; $V_I = V_{CCA}$ or GND	4.5 3.6	4.5 3.6	–	10 5.0	μA
ΔI_{CCB}	Increase in I_{CC} per Input Voltage, Other Inputs at V_{CCA} or GND	$V_I = V_{CCA} - 0.6 \text{ V}$; $V_I = V_{CCA}$ or GND	4.5 3.6	4.5 3.6	–	10 5.0	μA
I_{OZ}	I/O Tri-State Output Leakage Current	$T_A = 25^\circ C$, $\overline{OE} = 0V_{CCA}$, $V_O = 0$ to $V_{CCB} + 0.5 \text{ V}$	0.9 – 4.5	0.9 – 4.5	–	1.0	μA
		$T_A = 25^\circ C$, $\overline{OE} = 0V_{CCA}$, $V_O = 0$ to 4.5 V			–	75	

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TOTAL STATIC POWER CONSUMPTION ($I_{CCA} + I_{CCB}$)

V_{CCA} (V)	-40°C to +85°C										Unit	
	V_{CCB} (V)											
	4.5		3.3		2.8		1.8		0.9			
	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
4.5		2		2		2		2		< 1.5	µA	
3.3		2		2		2		2		< 1.5	µA	
2.8		< 2		< 1		< 1		< 0.5		< 0.5	µA	
1.8		< 1		< 1		< 0.5		< 0.5		< 0.5	µA	
0.9		< 0.5		< 0.5		< 0.5		< 0.5		< 0.5	µA	

NOTE: Connect ground before applying supply voltage V_{CCA} or V_{CCB} . This device is designed with the feature that the power-up sequence of V_{CCA} and V_{CCB} will not damage the IC.

AC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	V_{CCA} (V)	-40°C to +85°C										Unit	
			V_{CCB} (V)											
			4.5		3.3		2.8		1.8		1.5			
			Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
t_{PLH} , t_{PHL} (Note NO TAG)	Propagation Delay, A_n to B_n	4.5		3.0		3.2		3.4		3.7		4.0	nS	
		3.6		3.3		3.5		3.7		4.0		4.3		
		2.8		3.5		3.7		3.9		4.2		4.5		
		1.8		3.8		4.0		4.2		4.5		4.8		
		1.5		4.1		4.3		4.5		4.8		5.0		
t_{PZH} , t_{PZL} (Note NO TAG)	Output Enable, \overline{OE} to B_n	4.5		4.4		4.8		5.2		5.7		6.2	nS	
		3.3		4.7		5.1		5.5		6.0		6.5		
		2.8		4.9		5.3		5.7		6.2		6.7		
		1.8		5.2		5.6		6.0		6.5		7.0		
		1.5		5.5		5.9		6.3		6.8		7.3		
t_{PHZ} , t_{PLZ} (Note NO TAG)	Output Disable, \overline{OE} to B_n	4.5		4.4		4.8		5.2		5.7		6.2	nS	
		3.3		4.7		5.1		5.5		6.0		6.5		
		2.8		4.9		5.3		5.7		6.2		6.7		
		1.8		5.2		5.6		6.0		6.5		7.0		
		1.5		5.5		5.9		6.3		6.8		7.3		
t_{OSHL} , t_{OSLH} (Note NO TAG)	Output to Output Skew, Data to Out- put	4.1		0.15		0.15		0.15		0.15		0.15	nS	
		3.6		0.15		0.15		0.15		0.15		0.15		
		2.8		0.15		0.15		0.15		0.15		0.15		
		1.8		0.15		0.15		0.15		0.15		0.15		
		1.2		0.15		0.15		0.15		0.15		0.15		

1. Propagation delays defined per Figures 3 and 4.

CAPACITANCE

Symbol	Parameter	Test Conditions						Typ (Note 2)	Unit
C_{IN}	Control Pin Input Capacitance	$V_{CCA} = V_{CCB} = 3.3$ V, $V_I = 0$ V or $V_{CCA/B}$						3.5	pF
$C_{I/O}$	I/O Pin Input Capacitance	$V_{CCA} = V_{CCB} = 3.3$ V, $V_I = 0$ V or $V_{CCA/B}$						5.0	pF
C_{PD}	Power Dissipation Capacitance	$V_{CCA} = V_{CCB} = 3.3$ V, $V_I = 0$ V or V_{CCA} , $f = 10$ MHz						20	pF

2. Typical values are at $T_A = +25^\circ\text{C}$.

3. C_{PD} is defined as the value of the IC's equivalent capacitance from which the operating current can be calculated from:

$$I_{CC(\text{operating})} \cong C_{PD} \times V_{CC} \times f_{IN} \times N_{SW} \text{ where } I_{CC} = I_{CCA} + I_{CCB} \text{ and } N_{SW} = \text{total number of outputs switching.}$$

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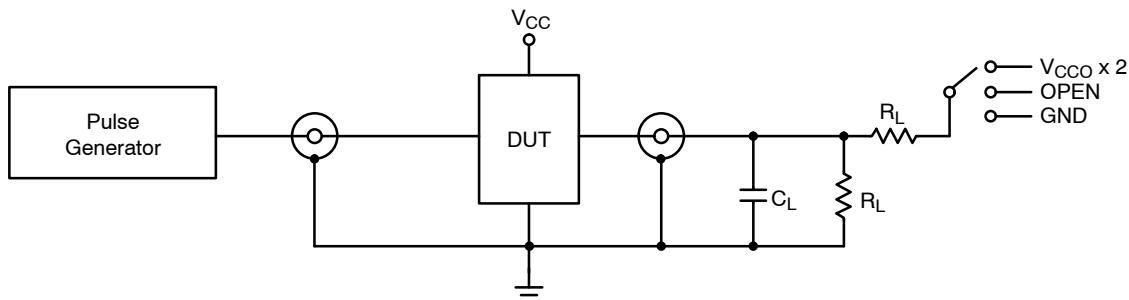
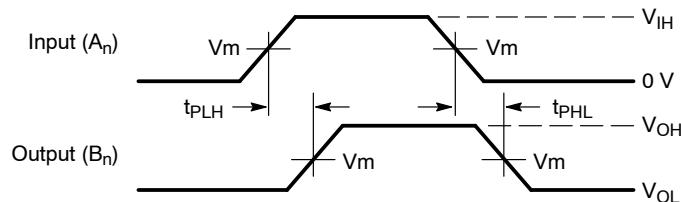


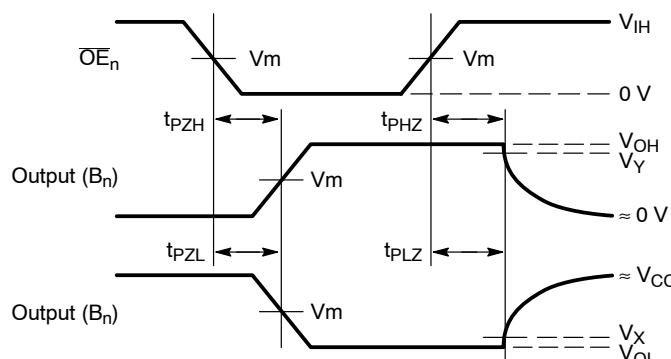
Figure 3. AC (Propagation Delay) Test Circuit

Test	Switch
t_{PLH}, t_{PHL}	OPEN
t_{PLZ}, t_{PZL}	$V_{CCO} \times 2$
t_{PHZ}, t_{PZH}	GND

$C_L = 15 \text{ pF}$ or equivalent (includes probe and jig capacitance)
 $R_L = 2 \text{ k}\Omega$ or equivalent
 Z_{OUT} of pulse generator = 50Ω



Waveform 1 – Propagation Delays
 $t_R = t_F = 2.0 \text{ ns}$, 10% to 90%; $f = 1 \text{ MHz}$; $t_W = 500 \text{ ns}$



Waveform 2 – Output Enable and Disable Times
 $t_R = t_F = 2.0 \text{ ns}$, 10% to 90%; $f = 1 \text{ MHz}$; $t_W = 500 \text{ ns}$

Figure 4. AC (Propagation Delay) Test Circuit Waveforms

Symbol	V_{CC}				
	3.0 V – 4.5 V	2.3 V – 2.7 V	1.65 V – 1.95 V	1.4 V – 1.6 V	0.9 V – 1.3 V
V_{mA}	$V_{CCA}/2$	$V_{CCA}/2$	$V_{CCA}/2$	$V_{CCA}/2$	$V_{CCA}/2$
V_{mB}	$V_{CCB}/2$	$V_{CCB}/2$	$V_{CCB}/2$	$V_{CCB}/2$	$V_{CCB}/2$
V_X	$V_{OL} \times 0.1$				
V_Y	$V_{OH} \times 0.9$				

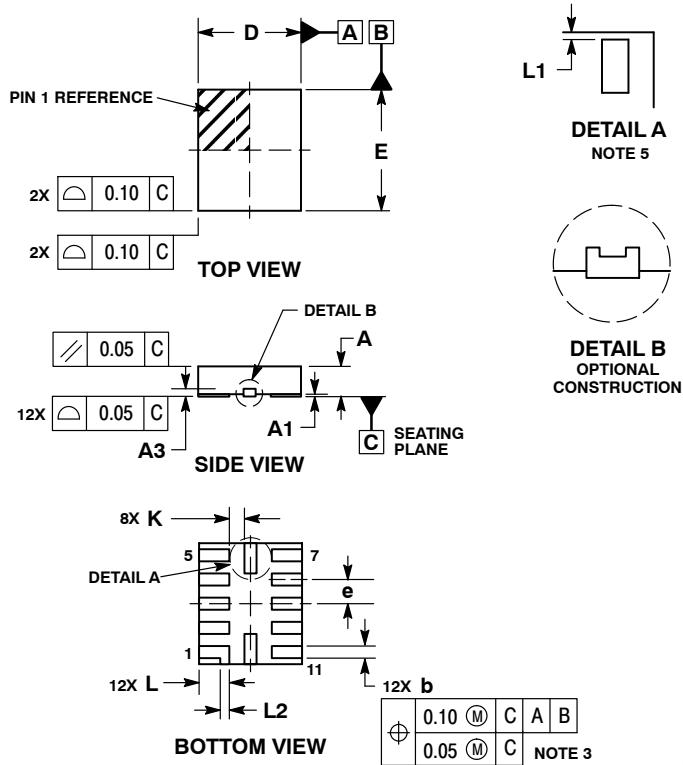
NLSV4T244E

PACKAGE DIMENSIONS

UQFN12 1.7x2.0, 0.4P

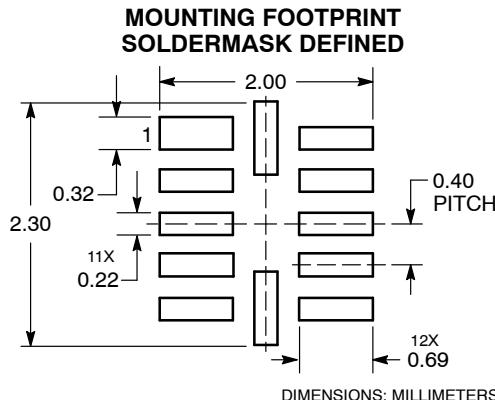
CASE 523AE-01

ISSUE A



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS
 3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
 4. MOLD FLASH ALLOWED ON TERMINALS ALONG EDGE OF PACKAGE. FLASH 0.03 MAX ON BOTTOM SURFACE OF TERMINALS.
 5. DETAIL A SHOWS OPTIONAL CONSTRUCTION FOR TERMINALS.

DIM	MILLIMETERS	
	MIN	MAX
A	0.45	0.55
A1	0.00	0.05
A3	0.127 REF	
b	0.15	0.25
D	1.70 BSC	
E	2.00 BSC	
e	0.40 BSC	
K	0.20	----
L	0.45	0.55
L1	0.00	0.03
L2	0.15 REF	

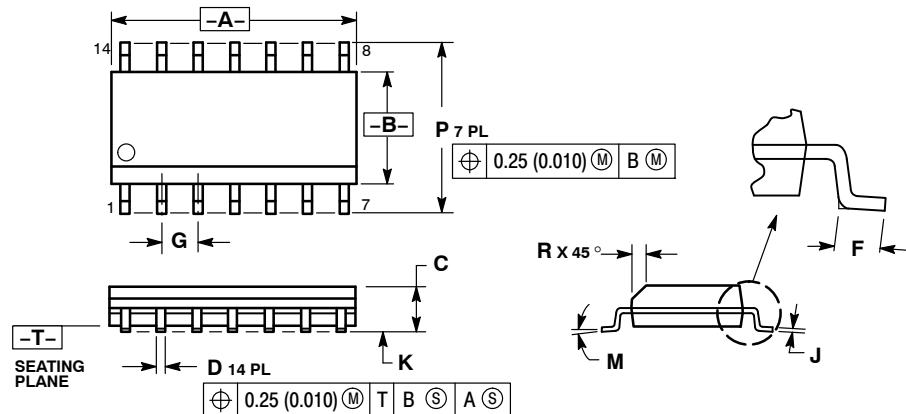


*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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PACKAGE DIMENSIONS

**SOIC-14
D SUFFIX
CASE 751A-03
ISSUE J**

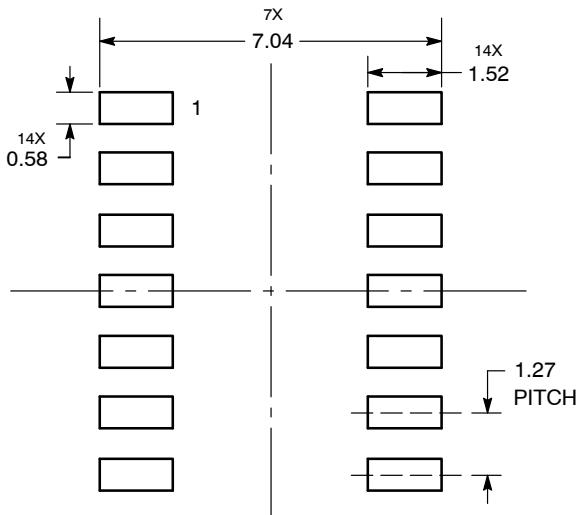


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27	BSC	0.050	BSC
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0 °	7 °	0 °	7 °
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

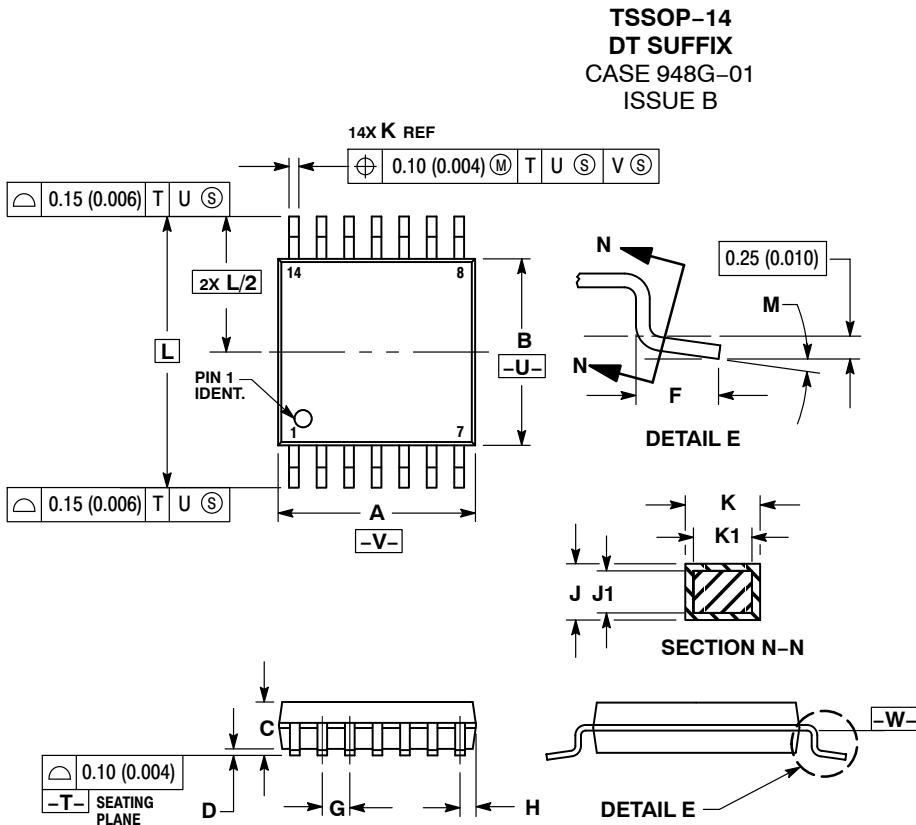
SOLDERING FOOTPRINT



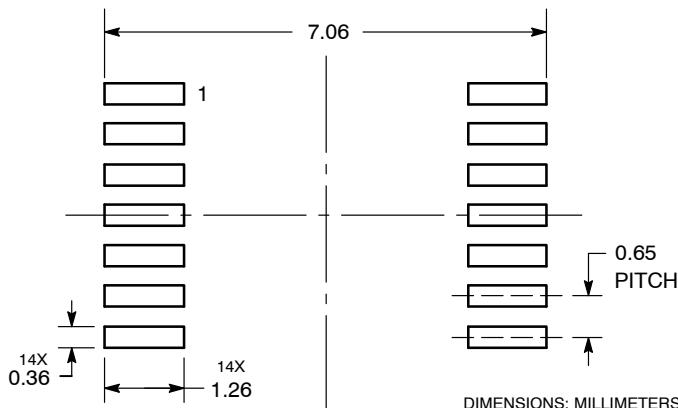
DIMENSIONS: MILLIMETERS

NLSV4T244E

PACKAGE DIMENSIONS



SOLDERING FOOTPRINT



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